



FZT951

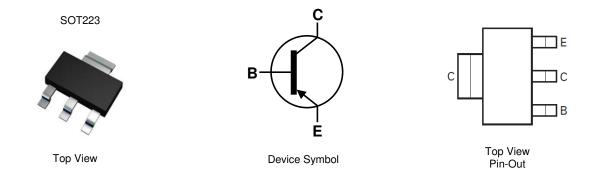
60V PNP MEDIUM POWER TRANSISTOR IN SOT223

Features

- BV_{CEO} > -60V
- I_C = -5A High Continuous Collector Current
- I_{CM} = -15A Peak Pulse Current
- Low Saturation Voltage V_{CE(SAT)} < -140mV @ -1A
- $R_{CE(SAT)} = 55m\Omega$ for a Low Equivalent On-Resistance
- hFE Specified up to -10A for a High Gain Hold-Up
- Complementary NPN Type: FZT851
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.112 grams (Approximate)



Ordering Information (Notes 4 & 5)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
FZT951TA	AEC-Q101	FZT951	7	12	1000
FZT951TC	AEC-Q101	FZT951	13	12	4000
FZT951QTA	Automotive	FZT951	7	12	1000
FZT951QTC	Automotive	FZT951	13	12	4000

Notes:

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

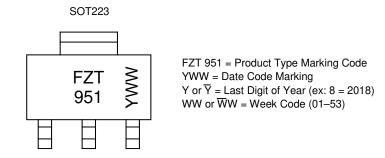
Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.

5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-100	V
Collector-Emitter Voltage	V _{CEO}	-60	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	lc	-5	A
Peak Pulse Current	I _{CM}	-15	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Power Dissipation	(Note 6)		3.0 24	W mW /°C
Linear Derating Factor	(Note 7)	P _D -	1.6 12.8	
Thermal Resistance, Junction to Ambient	(Note 6)	R _{OJA}	42	
	(Note 7)	R _{OJA}	78	°C/W
Thermal Resistance Junction to Lead	(Note 8)	R _{ƏJL}	8.8	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

ESD Ratings (Note 9)

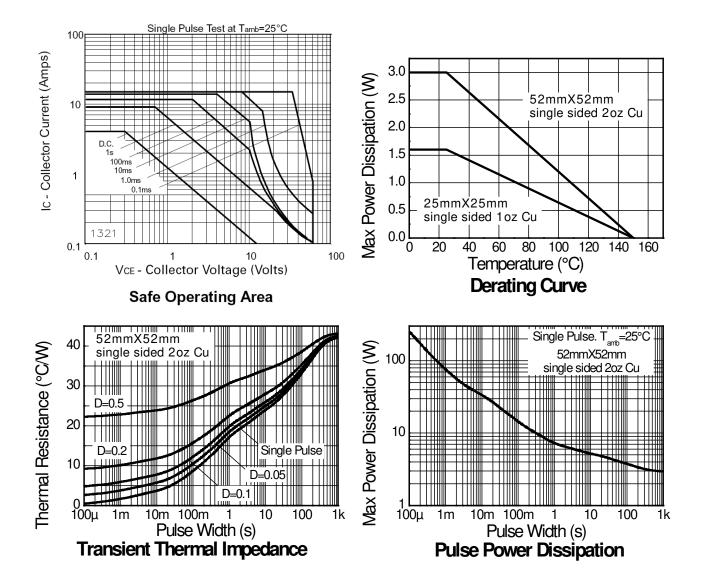
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge—Human Body Model	ESD HBM	8000	V	3B
Electrostatic Discharge—Machine Model	ESD MM	400	V	С

Notes: 6. For a device mounted with the collector lead on 52mm × 52mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.

Same as Note 6, except the device is mounted on 25mm × 25mm 1oz copper.
 Thermal resistance from junction to solder-point (at the end of the collector lead).
 Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

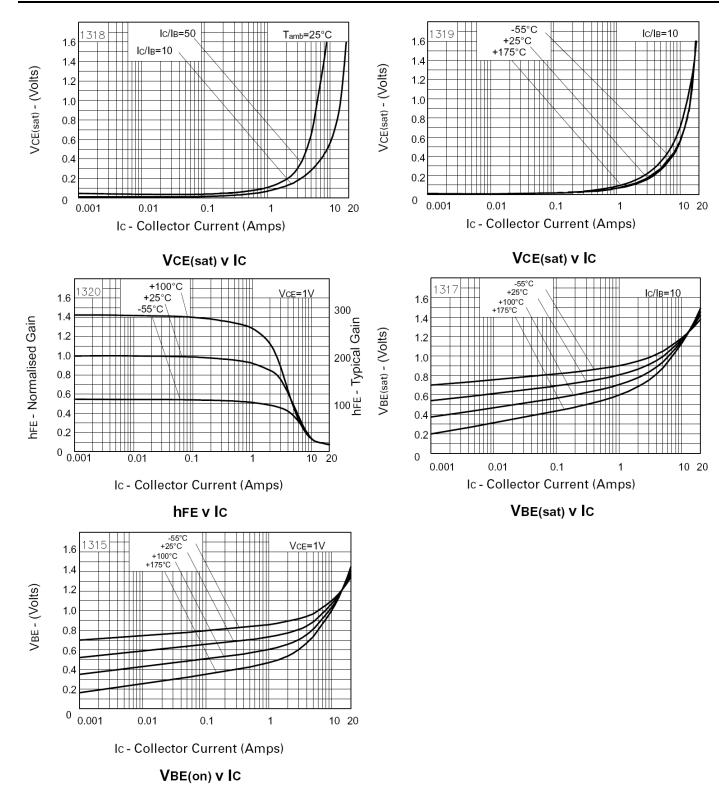
Characteristic	Symbol	Min	Typ.	Max	Unit	Test Condition
Collector-Base Breakdown Voltage		-100	-140	IVIAX	V	
5	BV _{CBO}		-		-	$I_{\rm C} = -100\mu A$
Collector-Emitter Breakdown Voltage (Note 10)	BV _{CER}	-100	-140		V	$I_{\rm C} = -1\mu A, R_{\rm B} \le 1k\Omega$
Collector-Emitter Breakdown Voltage (Note 10)	BV _{CEO}	-60	-90	—	V	$I_{\rm C} = -10 {\rm mA}$
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-8	—	V	I _E = -100μA
Collector Cut-Off Current	I _{CBO}	—	<-1	-50	nA	$V_{CB} = -80V$
			—	-1	μΑ	$V_{CB} = -80V, T_A = +100^{\circ}C$
Collector Cut Off Current	I _{CER}		<-1	-50	nA	V _{CE} = -80V, R ≤ 1kΩ
Collector Cut-Off Current		_	—	-1	μA	V _{CE} = -80V, T _A = +100°C
Emitter Cut-Off Current	I _{EBO}	_	<1	-10	nA	V _{EB} = -6V
DC Current Transfer Static Ratio (Note 10)	h _{FE}	100	200	_	—	$I_{C} = -10 \text{mA}, V_{CE} = -1 \text{V}$
		100	200	300		$I_{C} = -2A, V_{CE} = -1V$
		75	90	—		$I_{\rm C} = -5A, V_{\rm CE} = -1V$
		10	25	_		$I_{C} = -10A, V_{CE} = -1V$
	V _{CE(SAT)}	_	-20	-50	mV	I _C = -100mA, I _B = -10mA
Collector Emitter Seturation Voltage (Note 10)			-85	-140		$I_{\rm C} = -1$ A, $I_{\rm B} = -100$ mA
Collector-Emitter Saturation Voltage (Note 10)		_	-155	-210		$I_{\rm C} = -2A, I_{\rm B} = -200 {\rm mA}$
			-370	-460		$I_{\rm C} = -5A, I_{\rm B} = -500 {\rm mA}$
Base-Emitter Saturation Voltage (Note 10)	V _{BE(SAT)}	_	-1080	-1240	mV	$I_{\rm C} = -5A, I_{\rm B} = -500 {\rm mA}$
Base-Emitter Turn-On Voltage (Note 10)	V _{BE(ON)}	_	-935	-1070	mV	I _C = -5A, V _{CE} = -1V
Transitional Frequency (Note 10)	fT	—	120	—	MHz	$I_{C} = -100 \text{mA}, V_{CE} = -10 \text{V},$ f = 50MHz
Output Capacitance	C _{OBO}	_	74	_	pF	V _{CB} = -10V, f = 1MHz
Switching Time	ton	_	82	_		$V_{CC} = -10V, I_{C} = -2A,$
Switching Time	tOFF	—	350	—	ns	$-I_{B1} = I_{B2} = -200 \text{mA}$

Note: 10. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.



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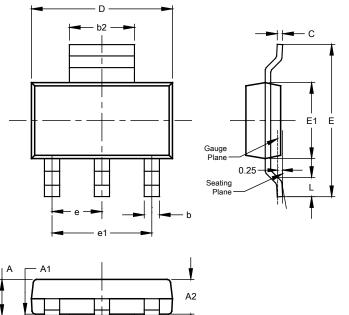
Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)





Package Outline Dimensions

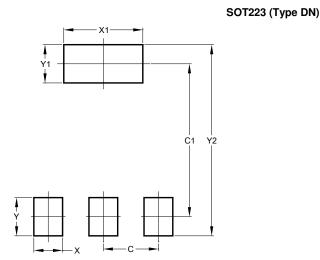
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT223 (Type DN)						
Dim	Min	Min Max Ty				
Α		1.70				
A1	0.01	0.15				
A2	1.50	1.68	1.60			
b	0.60	0.80	0.70			
b2	2.90	3.10				
c	0.20	0.32				
D	6.30	6.70				
E	6.70	7.30				
E1	3.30	3.70				
e			2.30			
e1		-	4.60			
L	0.85					
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions Value (in mm) C 2.30 C1 6.40 X 1.20 X1 3.30 Y 1.60 Y1 1.60 Y2 8.00

SOT223 (Type DN)



FZT951

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